

N-CHANNEL 100V - 0.030 Ω - 25A DPAK LOW GATE CHARGE STripFET™ II POWER MOSFET

ТҮРЕ	V _{DSS}	R _{DS(on)}	ID
STD25NF10L	100 V	< 0.035 Ω	25 A

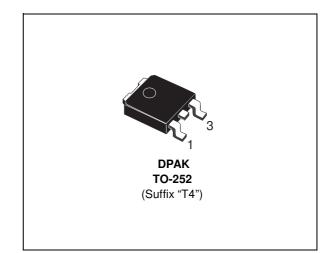
- TYPICAL R_{DS}(on) = 0.030 Ω
- EXCEPTIONAL dv/dt CAPABILITY
- 100% AVALANCHE TESTED
- LOW THRESHOLD DEVICE
- LOGIC LEVEL DEVICE
- SURFACE-MOUNTING DPAK (TO-252) POWER PACKAGE IN TAPE & REEL (SUFFIX "T4")

DESCRIPTION

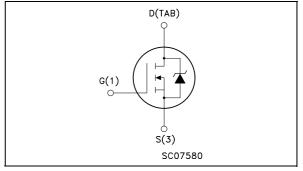
This MOSFET series realized with STMicroelectronics unique STripFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced highefficiency, high-frequency isolated DC-DC converters for Telecom and Computer applications. It is also intended for any applications with low gate drive requirements

APPLICATIONS

- HIGH-EFFICIENCY DC-DC CONVERTERS
- UPS AND MOTOR CONTROL



INTERNAL SCHEMATIC DIAGRAM



Symbol	Parameter	Value	Unit
V _{DS}	Drain-source Voltage (V _{GS} = 0)	100	V
V _{DGR}	Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)	100	V
V _{GS}	Gate- source Voltage	± 16	V
I _D (*)	Drain Current (continuous) at $T_C = 25^{\circ}C$	25	A
I _D	Drain Current (continuous) at $T_C = 100^{\circ}C$	25	A
I _{DM} (●)	Drain Current (pulsed)	100	A
P _{tot}	Total Dissipation at $T_C = 25^{\circ}C$	100	W
	Derating Factor	0.67	W/°C
dv/dt (1)	Peak Diode Recovery voltage slope	20	V/ns
E _{AS} (2)	Single Pulse Avalanche Energy	450	mJ
T _{stg}	Storage Temperature	-55 to 175	°C
Тј	Max. Operating Junction Temperature	-55 10 175	U
(•) Pulse width I (*) Current Lin	imited by safe operating area. nited by Package	(1) $I_{SD} \le 25A$, di/dt $\le 300A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_j \le 7$ (2) Starting $T_j = 25 \text{ °C}$, $I_D = 12.5A$, $V_{DD} = 50V$	T _{JMAX}
February 2003	3		1/9

ABSOLUTE MAXIMUM RATINGS

THERMAL DATA

Rthj-case Rthj-pcb Tı	Thermal Resistance Junction-case Thermal Resistance Junction-pcb ^(#) Maximum Lead Temperature For Soldering Purpose	Max Max	1.5 50 275	°C/W °C/W °C
'	Maximum Lead temperature for boldening fulpose		210	0

(#) When Mounted on 1 inch² FR-4 board, 2 oz of Cu.

ELECTRICAL CHARACTERISTICS (T_{CASE} = 25 °C UNLESS OTHERWISE SPECIFIED) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	100			V
I _{DSS}	Zero Gate Voltage Drain Current ($V_{GS} = 0$)	V_{DS} = Max Rating V_{DS} = Max Rating T _C = 125°C			1 10	μΑ μΑ
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	V _{GS} = ± 16 V			±100	nA

ON (*)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$	I _D = 250 μA	1		2.5	V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 10 V V _{GS} = 4.5 V	I _D = 12.5 A I _D = 12.5 A		0.030 0.035	0.035 0.040	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	V _{DS} = 15 V I _D = 12.5 A		24		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V_{DS} = 25V f = 1 MHz V_{GS} = 0		1710 250 110		pF pF pF

57

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Delay Time Rise Time			20 40		ns ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V _{DD} = 80 V I _D = 25 A V _{GS} = 5 V		38 8.5 21	52	nC nC nC

SWITCHING OFF

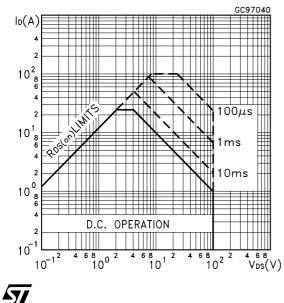
Symbol	Parameter	Test Co	nditions	ons Min.		Max.	Unit
t _{d(off)} t _f	Turn-off Delay Time Fall Time	$V_{DD} = 50 V$ $R_G = 4.7\Omega$, (Resistive Load	$I_D = 12.5 \text{ A}$ $V_{GS} = 5 \text{ V}$ d, Figure 3)		58 20		ns ns

SOURCE DRAIN DIODE

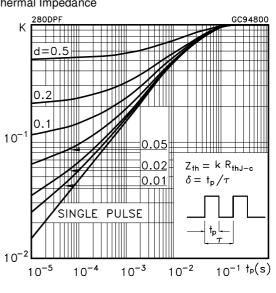
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} (●)	Source-drain Current Source-drain Current (pulsed)					25 100	A A
V _{SD} (*)	Forward On Voltage	I _{SD} = 25 A	$V_{GS} = 0$			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_{SD} = 25 \text{ A}$ $V_{DD} = 50 \text{ V}$ (see test circu	di/dt = 100A/µs T _j = 150°C it, Figure 5)		88 317 7.2		ns nC A

(*)Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %.
(•)Pulse width limited by safe operating area.

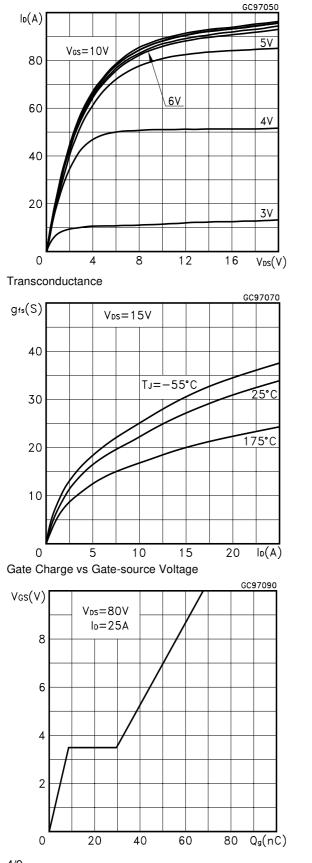
Safe Operating Area

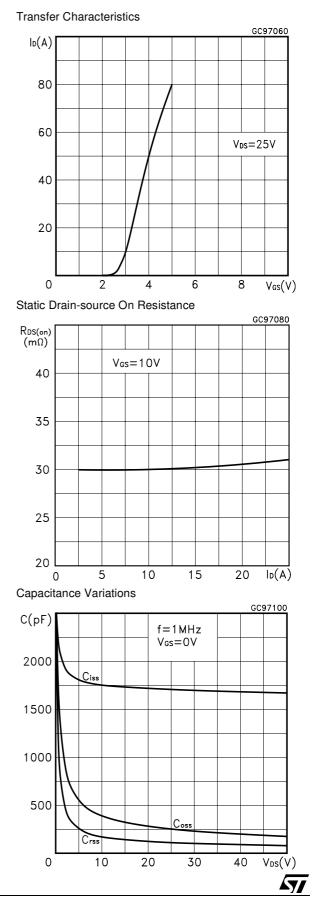


Thermal Impedance

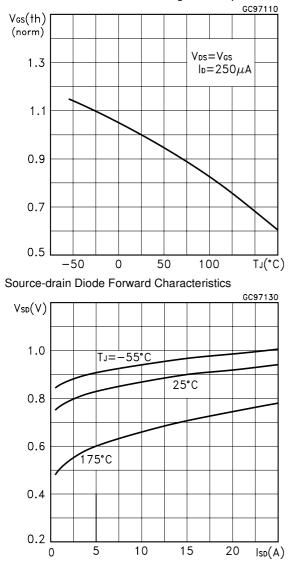


Output Characteristics





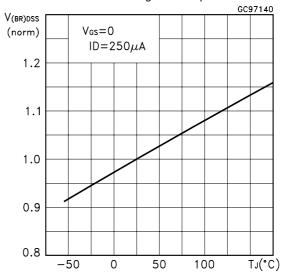
4/9



Normalized Gate Threshold Voltage vs Temperature



Normalized Breakdown Voltage vs Temperature



57

Fig. 1: Unclamped Inductive Load Test Circuit

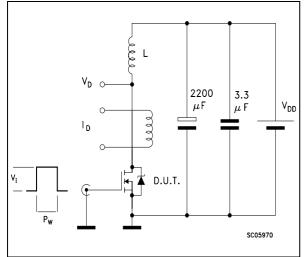


Fig. 3: Switching Times Test Circuits For Resistive Load

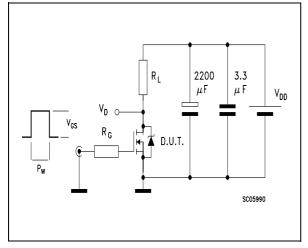


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

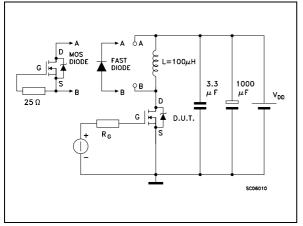


Fig. 2: Unclamped Inductive Waveform

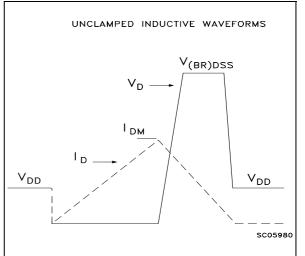
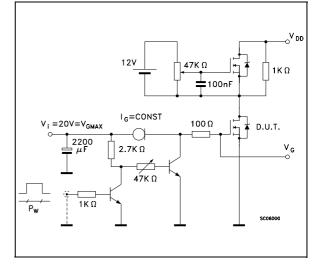


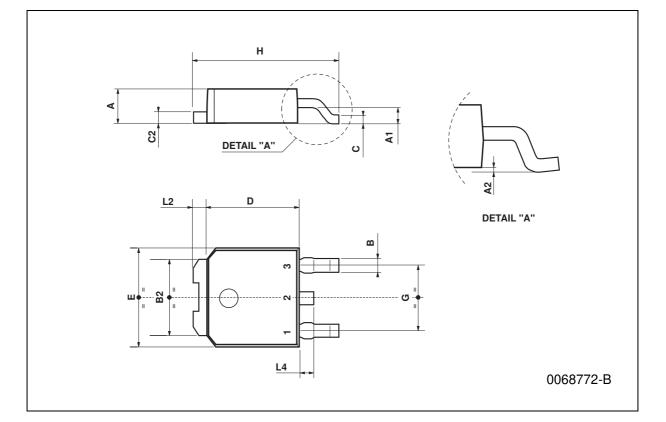
Fig. 4: Gate Charge test Circuit



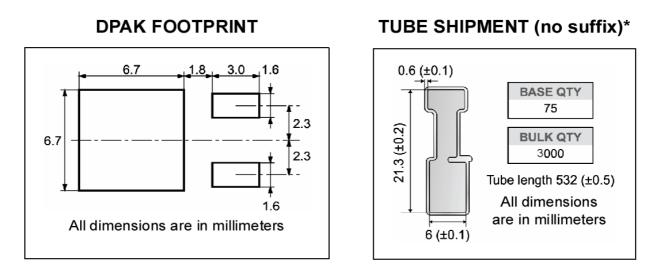
57

DIM.		mm			inch			
DIM.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
А	2.2		2.4	0.086		0.094		
A1	0.9		1.1	0.035		0.043		
A2	0.03		0.23	0.001		0.009		
В	0.64		0.9	0.025		0.035		
B2	5.2		5.4	0.204		0.212		
С	0.45		0.6	0.017		0.023		
C2	0.48		0.6	0.019		0.023		
D	6		6.2	0.236		0.244		
E	6.4		6.6	0.252		0.260		
G	4.4		4.6	0.173		0.181		
Н	9.35		10.1	0.368		0.397		
L2		0.8			0.031			
L4	0.6		1	0.023		0.039		

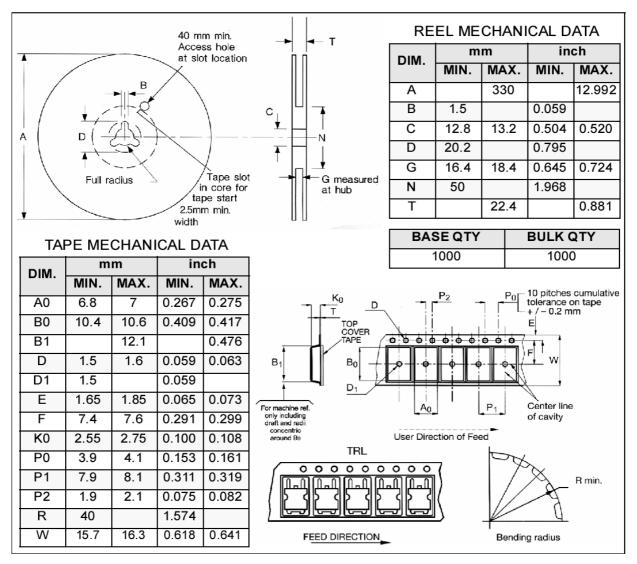




7/9



TAPE AND REEL SHIPMENT (suffix "T4")*



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8/9

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57